

SRPE-50E1A0

Non-Isolated DC-DC Converter

The Bel SRPE-50E1A0 is part of the non-isolated dc to dc converter Power Module series. The modules use a Vertical SMT package. These converters are available in a range of output voltages from 0.6 Vdc to 2.0 Vdc over a wide range of input voltage ($V_{in} = 7.5 - 13.2$ Vdc).

Key Features & Benefits

- 7.5-13.2 VDC Input / 0.6-2.0 VDC @ 50 A Output
- Non-isolated
- Fixed frequency
- High efficiency
- High Power Density
- Overtemperature Shutdown
- Wide Input Voltage Range
- Low Cost
- Wide Output Trim Range
- Output Over-Voltage Shutdown
- OCP/SCP
- Power Good Signal
- Remote Sense
- Remote On/Off
- Undervoltage lockout
- Wide Operating Temperature Range (0 °C - 50 °C)
- Class 2, Category 2, Isolated DC/DC Converter (refer to IPC-9592B)



Applications

- Networking
- Computers and peripherals
- Telecommunications

1. MODEL SELECTION

MODEL NUMBER	OUTPUT VOLTAGE	INPUT VOLTAGE	MAX. OUTPUT CURRENT	MAX. OUTPUT POWER	TYPICAL EFFICIENCY
SRPE-50E1A0	0.6-2.0 VDC	7.5-13.2 VDC	50A	100 W	91%

NOTE: Add "G" or "R" suffix at the end of the model number to indicate packaging.

PART NUMBER EXPLANATION

S	R	PE	-	50	E	1A	0	x
Mounting Type	RoHS Status	Series Name		Output Power	Input Range	Output Voltage	Active Logic	Package Type
Surface mount	RoHS	SMD		100 W	7.5-13.2 V	0.6-2.0 V	0–Active High	G – Tray package R – Tape and Reel packaging

2. ABSOLUTE MAXIMUM RATINGS

PARAMETER	DESCRIPTION	MIN	TYP	MAX	UNITS
Continuous non-operating Input Voltage		-0.3	-	15	V
Remote On/Off		-0.3	-	15	V
Ambient temperature		0	-	50	°C
Storage Temperature		-40	-	125	°C
Altitude		-	-	2000	m

NOTE: Ratings used beyond the maximum ratings may cause a reliability degradation of the converter or may permanently damage the device.

3. INPUT SPECIFICATIONS

All specifications are typical at 25°C unless otherwise stated.

PARAMETER	DESCRIPTION	MIN	TYP	MAX	UNIT
Operating Input Voltage		7.5	12	13.2	V
Input Current (full load)	Vin=12V, Vo=2V, Io=50A	8.8	9.3	10.3	A
	Vin=12V, Vo=0.9V, Io=50A	4.1	4.6	5.6	A
	Vin=12V, Vo=0.6V, Io=50A	2.8	3.3	4.3	A
Input Current (no load)	Vin=12V, Vo=0.9V	110	135	160	mA
	Vin=12V, Vo=0.6V	101	126	150	mA
	Vin=12V, Vo=2V	165	190	215	mA
Remote Off Input Current	Vin=12V	15	20	25	mA
Input Reflected Ripple Current (pk-pk)	Vin=12V, Vo=0.9V 1uH inductor×1, 100uf/100V×1	-	45	60	mA
Input Reflected Ripple Current (rms)	@25°C.	-	11	20	mA
Turn-on Voltage Threshold		7	7.2	7.5	V
Turn-off Voltage Threshold		6.2	6.4	7	V

CAUTION: All specifications are typical at 25 °C unless otherwise stated.

4. OUTPUT SPECIFICATIONS

All specifications are typical at nominal input, full load at 25°C unless otherwise stated.

PARAMETER	DESCRIPTION	MIN	TYP	MAX	UNIT
Output Voltage Set Point	Vin=12V, Iout=full load, Ta=25°C.	-3	-	3	% Vo, set
Load Regulation	Vin=12V, Io=0-20A, Ta=25°C	-2	-	2	% Vo, set
Line Regulation	Vin=8-14V, Io=10A, Ta=25°C	-2	-	2	% Vo, set
Regulation Over Temperature		-2	-	2	% Vo, set
Output Ripple and Noise(Pk-Pk)	Vin=12V, Iout=full load, Ta=25°C.	-	15	30	mV
Output Ripple and Noise(RMS)	Vin=12V, Iout=full load, Ta=25°C.	-	5	10	mV
Output Current Range		0	-	50	A
Output DC Current Limit		60	-	120	A
Turn on Time		-	3.5	5	ms
Output Capacitance	Recommendation: 6*22uF 0805, 6.3V ceramic caps 3*470uF 7mohm Polymer Caps	1300	1542	1800	uF
Transient Response					
ΔV 50%~75% of Max Load	di/dt=1A/us, Vin=12Vdc, Vo=0.9Vdc,	-	40	70	mV
Settling Time	Ta=25°C, with 1*0.1uF+1*1uF+ 6*22uF ceramic	-	50	80	us
ΔV 75%~50% of Max Load	capacitor and 3*470uF polymer cap at output.	-	40	70	mV
Settling Time		-	50	80	us

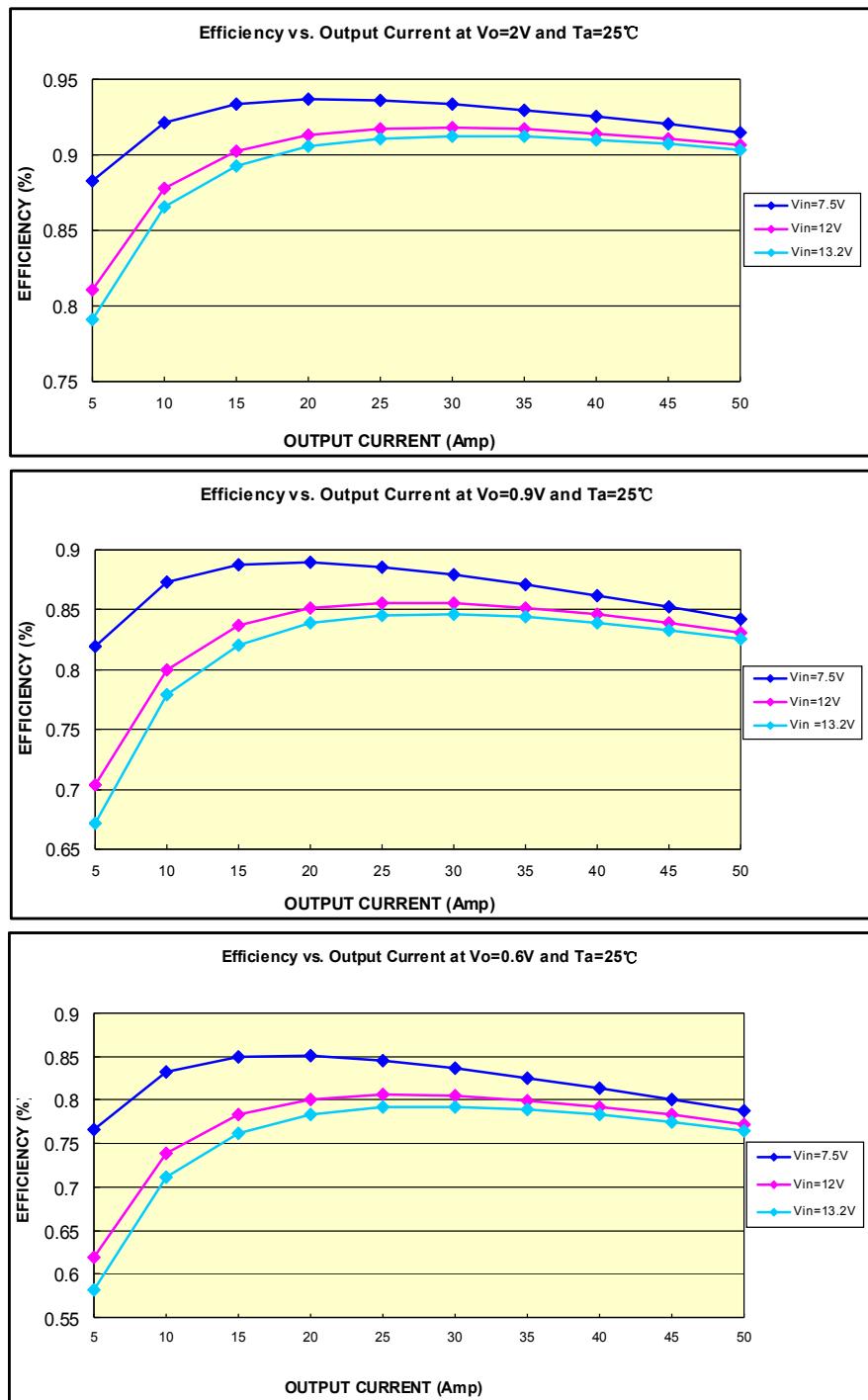
5. GENERAL SPECIFICATIONS

PARAMETER	DESCRIPTION	MIN	TYP	MAX	UNIT
Efficiency	The efficiency is measured at Vin=12V, Vout=2V, Iout=50A and Ta=25°C.	89.5	90.5	-	%
Switching Frequency	For per phase	300	350	400	kHz
Over Temperature Protection		-	-	-	°C
Output Voltage Trim Range (Wide Trim)		0.6	-	2	V
Weight		-	19	-	g
MTBF	Calculated Per Telcordia SR-332, Issue 3(Vin=12V, Vo=0.9V, Io=50A, Ta=40C, with 300 LFM, FIT=10⁹/MTBF)	-	31.7	-	M hrs
FIT		-	31.5	-	-
Dimensions		1.45 x 0.95 x 0.62		Inches	
Inches (L x W x H)		36.83 x 24.13 x 15.75		Millimeters	
Millimeters (L x W x H)					

6. CONTROL SPECIFICATIONS

PARAMETER	DESCRIPTION	MIN	TYP	MAX	UNIT
Remote On/Off					
Signal Low (Unit Off)	Remote On/Off pin open, unit off.	0	-	0.5	V
Signal High (Unit On)		1.8	-	15	V

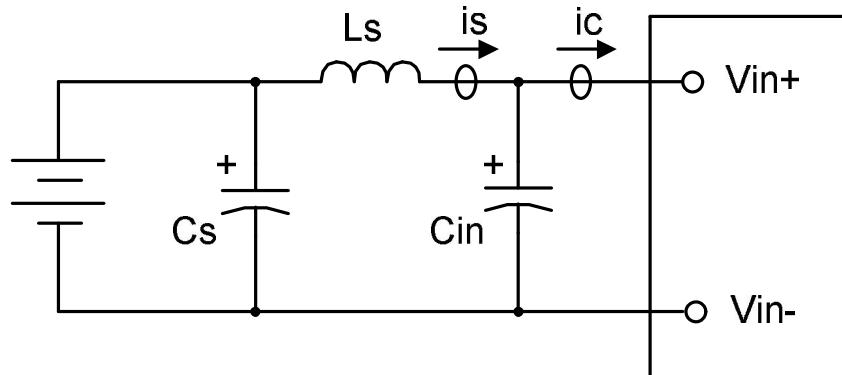
7. EFFICIENCY DATA



8. INPUT NOISE

Input reflected ripple current

Testing setup



Notes and values in testing.

is: Input Reflected Ripple Current

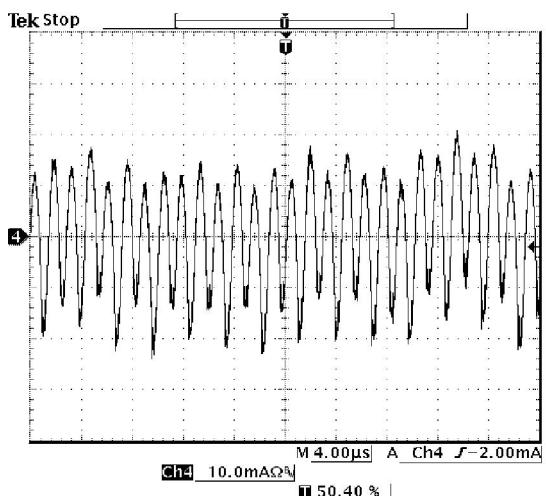
ic: Input Terminal Ripple Current

Ls: Simulated Source Impedance (1μH)

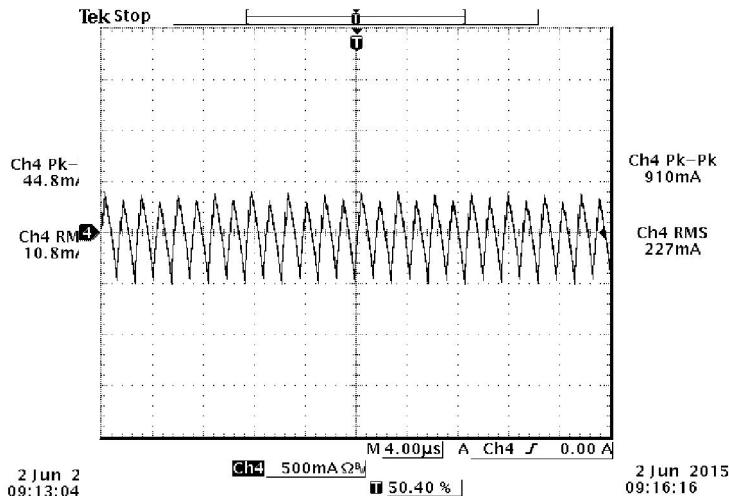
Cs: Offset possible source Impedance (100μF, ESR<0.2Ω @ 100kHz, 20C)

Cin: Electrolytic capacitor, should be as closed as possible to the power module to swallow ic ripple current and help with stability. Recommendation: 100μF, ESR<0.2Ω @ 100kHz, 20C.

Below measured waveforms are based on above simulated and recommended inductance and capacitance.



is (input reflected ripple current), AC component

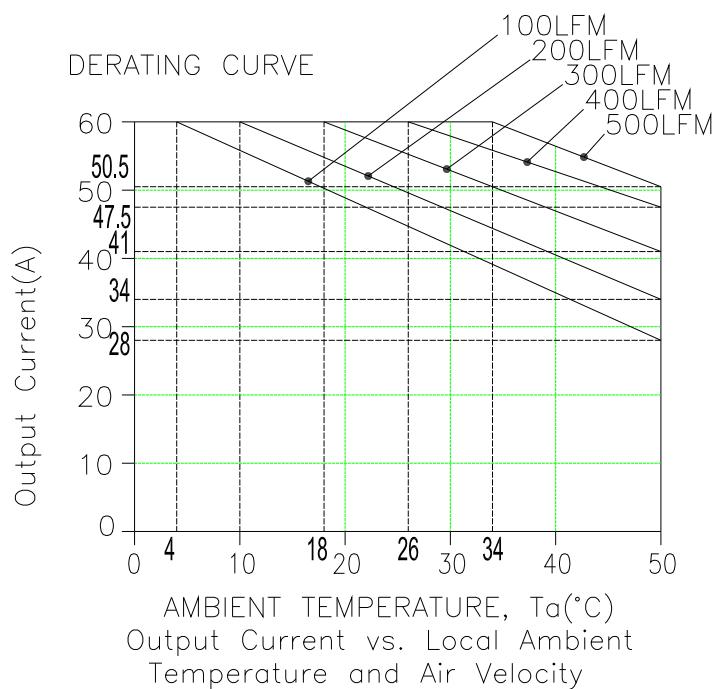
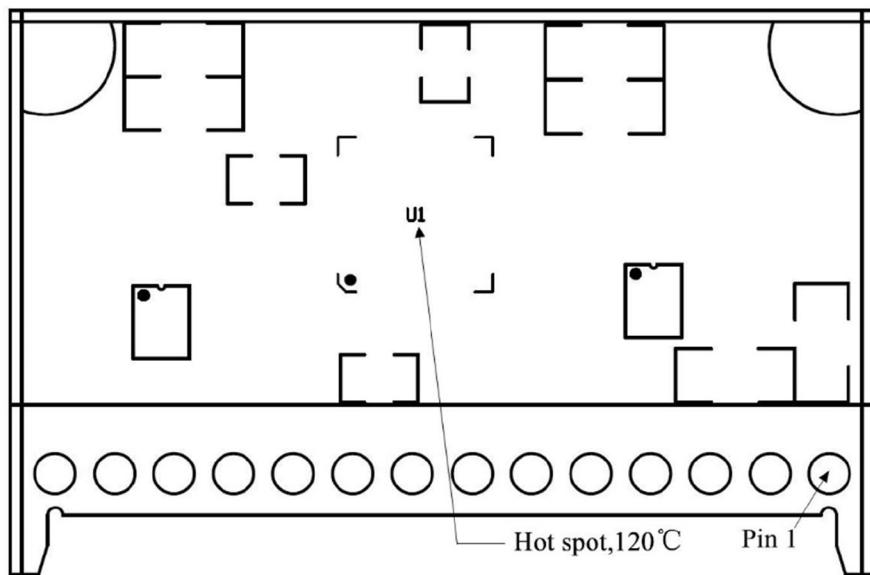


ic (input terminal ripple current), AC component

Note: $V_{in}=12V$, $V_o=0.9V$, $I_o=50A$, with $1*0.1\mu F + 1*1\mu F + 6*22\mu F$ ceramic and $3*470\ \mu F$ polymer capacitor at the output, $T_a=25$ deg C.

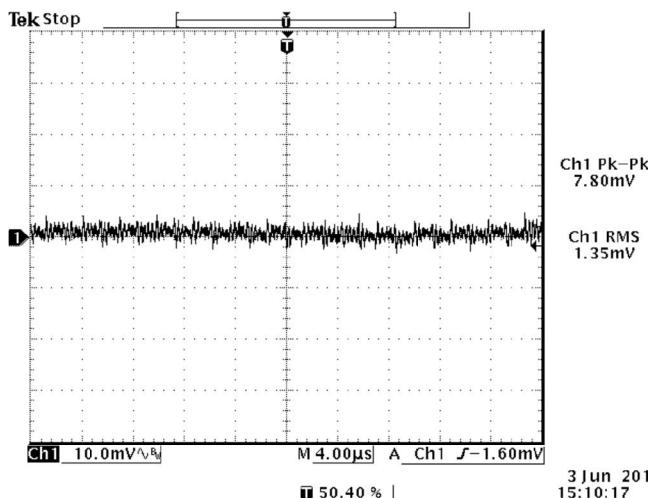
9. THERMAL DERATING CURVE

Hot spot location and allowed maximum temperature

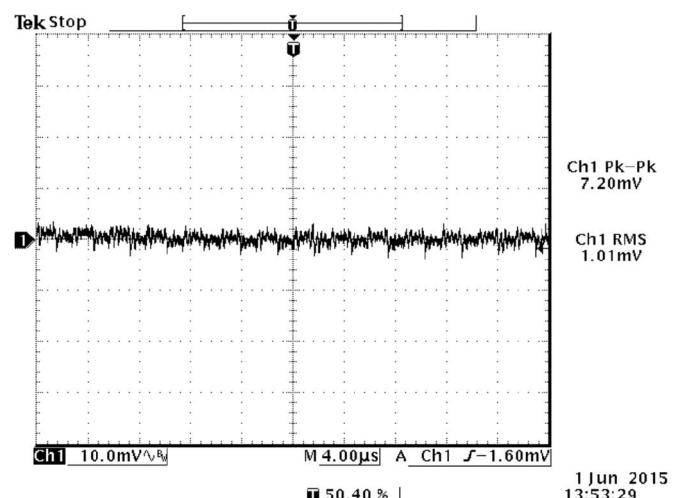


$V_{in}=12V$, $V_o=0.9V$

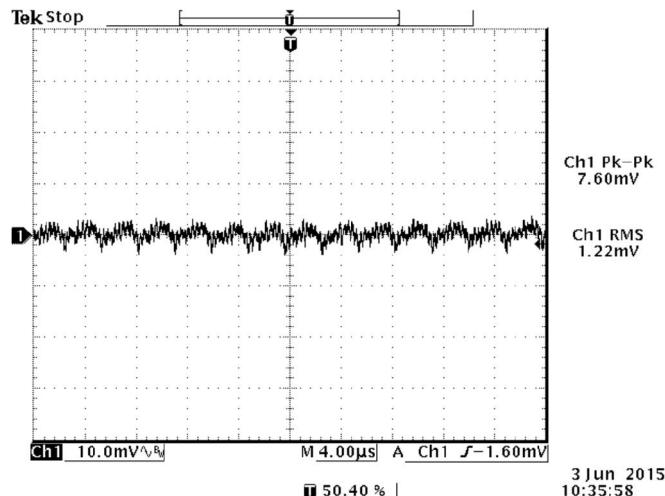
10. RIPPLE AND NOISE WAVEFORM



$V_{in}=12V, V_o=0.6V, I_o=50A$



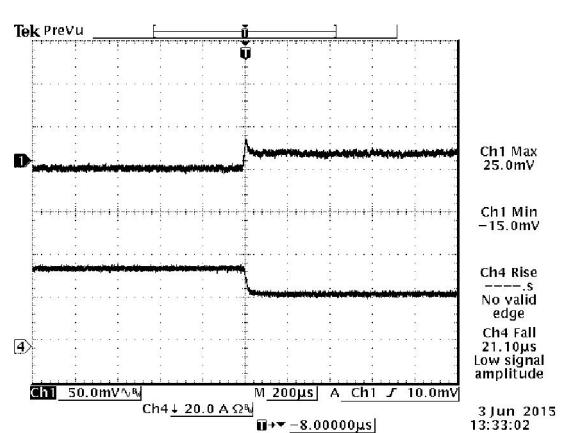
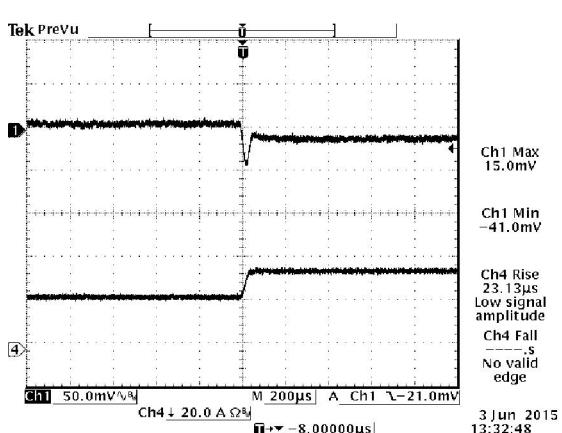
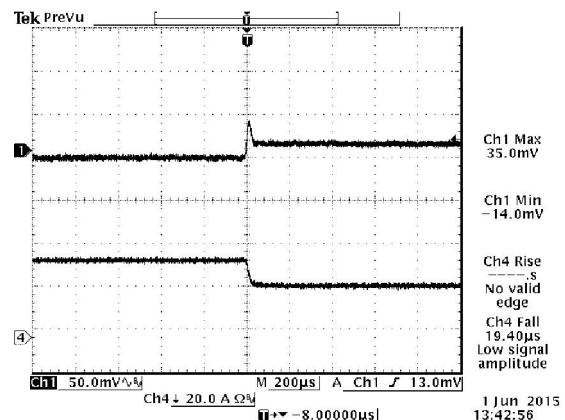
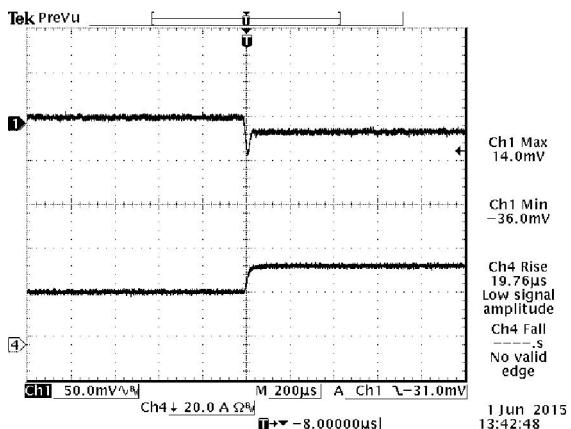
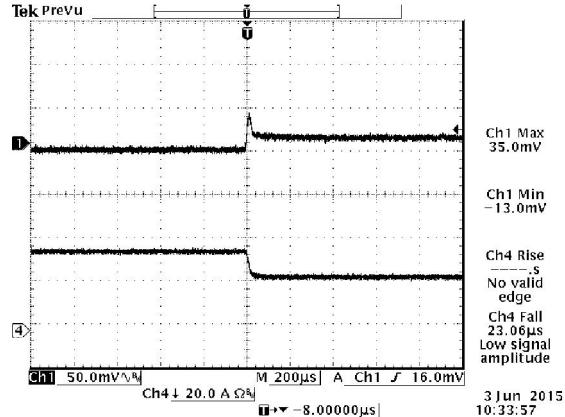
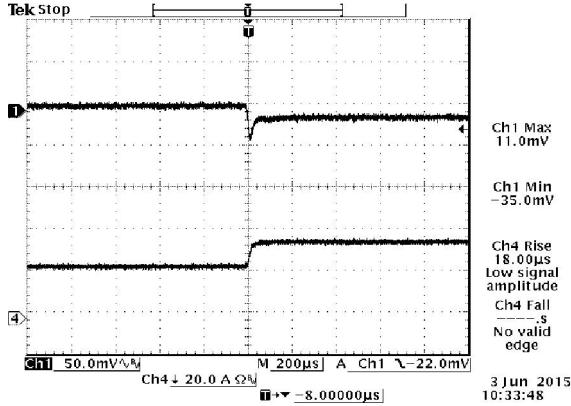
$V_{in}=12V, V_o=0.9V, I_o=50A$



$V_{in}=12V, V_o=2V, I_o=50A$

Note: Ripple and noise at full load, 0-20MHz BW, with 1*0.1uf+1*1uf+6*22uf ceramic and 3*470 uF polymer capacitor at the output, Ta=25 deg C.

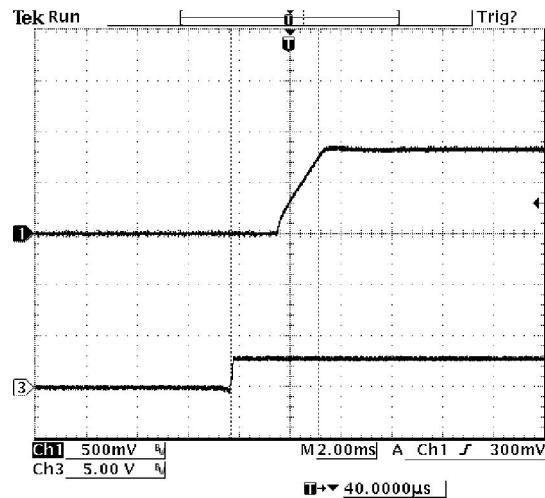
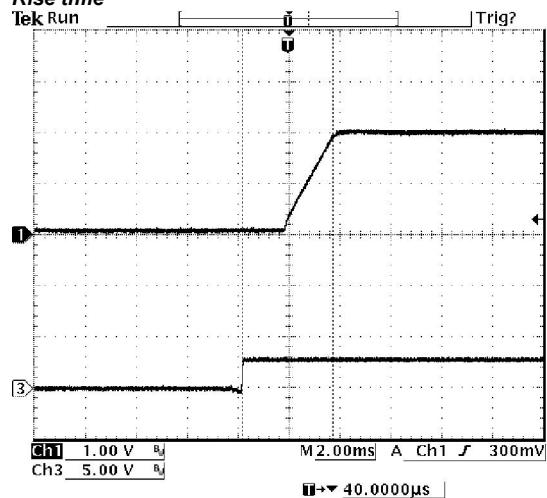
11. TRANSIENT RESPONSE WAVEFORMS



Note: Transient response at $di/dt=1A/\mu s$, with $1*0.1\mu F+1*1\mu F+6*22\mu F$ ceramic and $3*470\mu F$ polymer capacitor at the output, $T_a=25$ deg C.

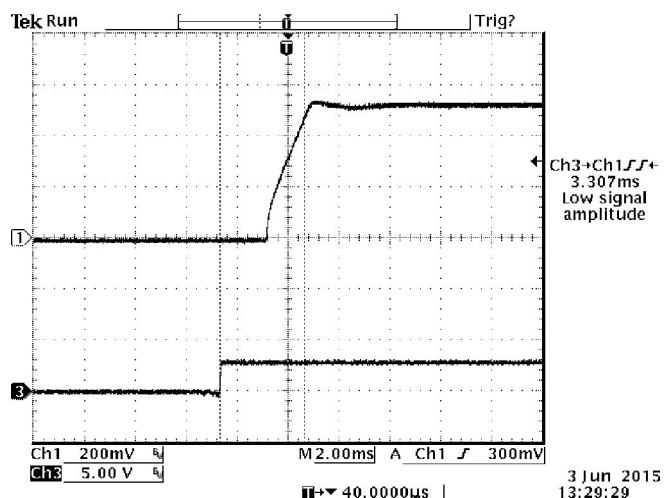
12. STARTUP&SHUTDOWN

Rise time



$V_{in}=12V$, $V_o=2V$, $I_o=50A$

$V_{in}=12V$, $V_o=0.9V$, $I_o=50A$



$V_{in}=12V$, $V_o=0.6V$, $I_o=50A$

Note: With 1*0.1uf+1*1uf+6*22uf ceramic and 3*470 uF polymer capacitor at the output, $T_a=25$ deg C.

13. TRIM

Output Voltage Set-Point Adjustment

Maximum trim up voltage is 2V.

Minimum trim up voltage is 0.6V.

1.Trim up circuit (using an external resistor)

Equations for calculating the trim resistor are shown below.

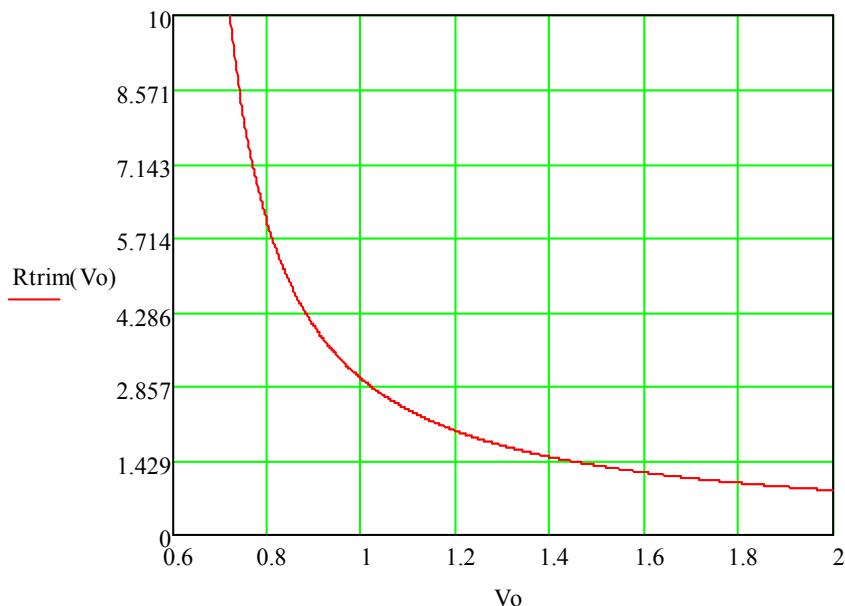
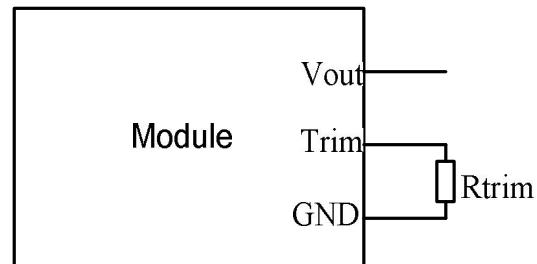
The Trim Up resistor should be connected between the Trim pin and GND pin.

$$R_{trim} = \frac{1.2}{V_o - 0.6} (K\Omega)$$

SRPE-50E1A0 Trim up Resistor Calculate Unit: KΩ

V_o is the desired output voltage

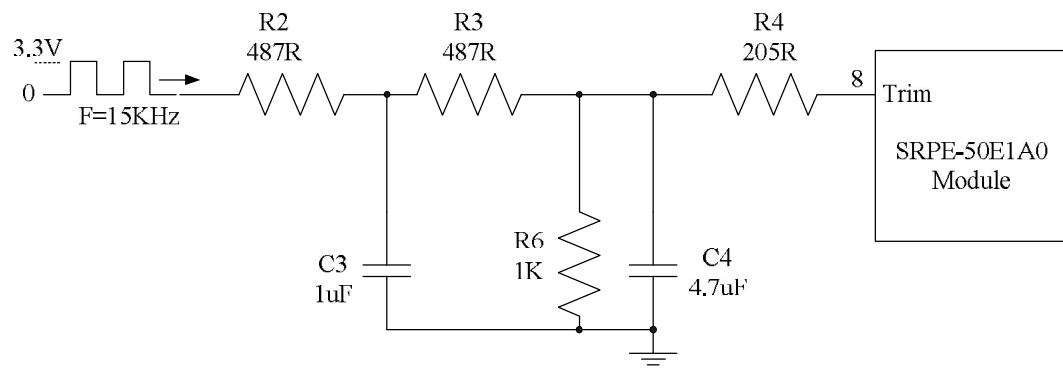
R_{trim} is the required resistance between TRIM and GND



TRIM (CONTINUED)

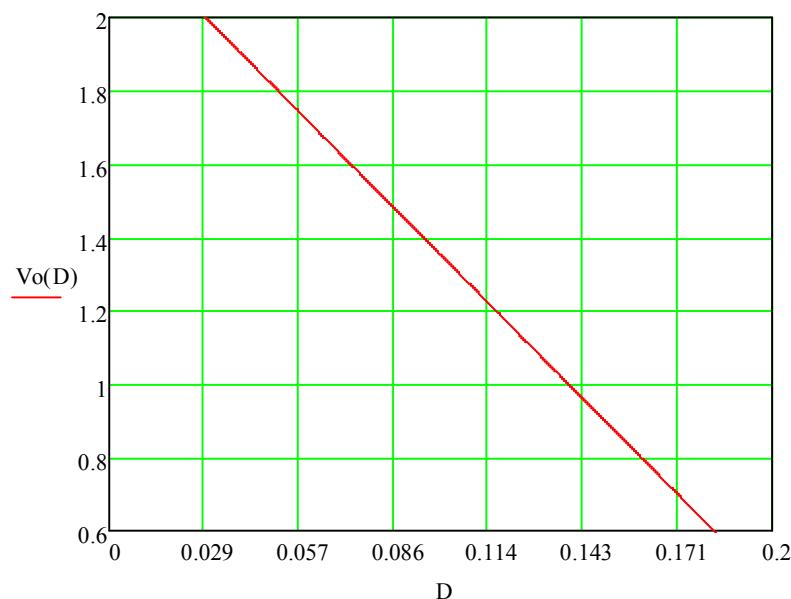
2. Trim up circuit (using external PWM signal)
 Equations for calculating the duty cycle are shown below.

$$V_o(D) = 2.265 - 9.13D$$

**SRPE-50E1A0 Trim up duty cycle Calculate**

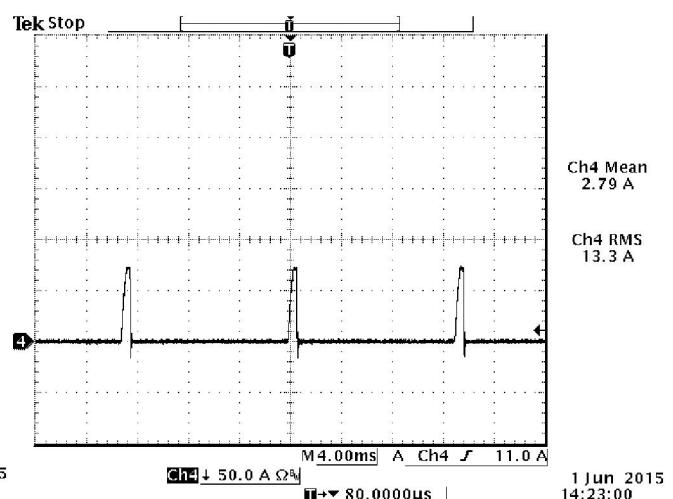
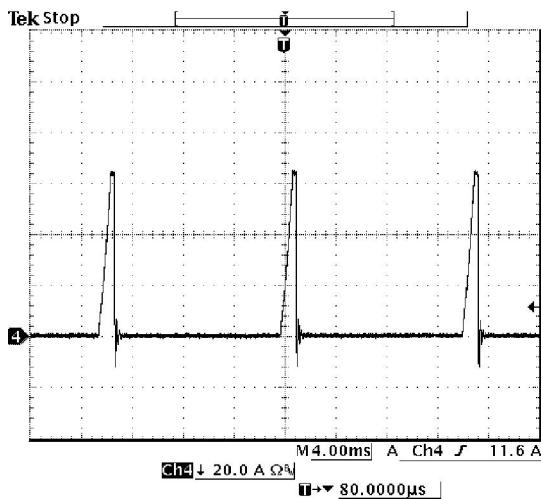
V_o is the desired output voltage

D is the external PWM signal duty cycle.



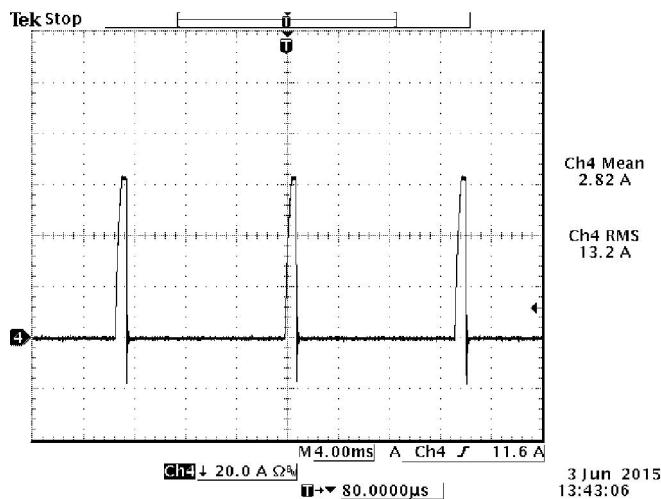
14. OCP

To provide protection in a fault output overload condition, the module is equipped with internal current-limiting circuitry and can endure current limiting for a few mili-seconds. If the overcurrent condition persists beyond a few milliseconds, the module will shut down into hiccup mode and restart once every 14ms. The module operates normally when the output current goes into specified range. The typical average output current is 3A during hiccup.



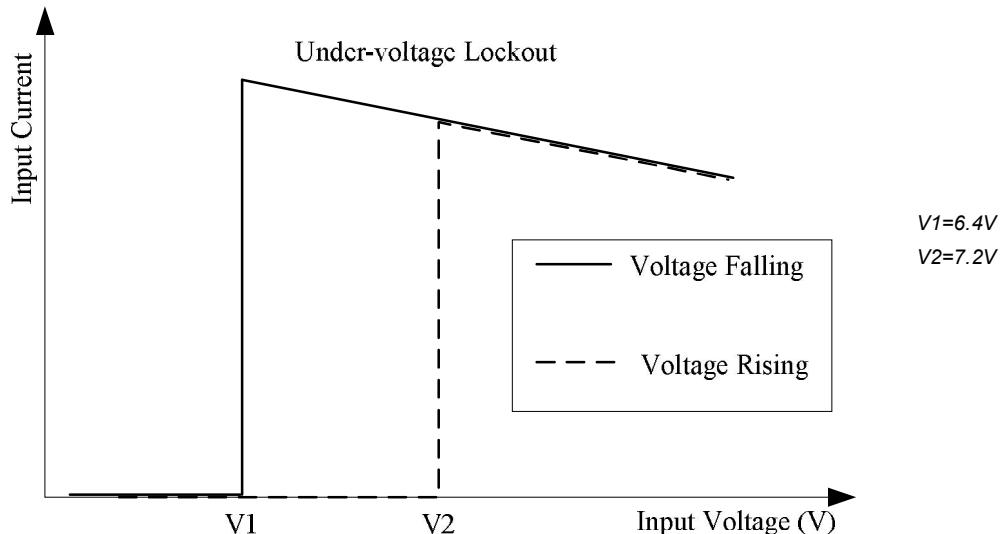
$V_{in}=12V, V_o=2V$

$V_{in}=12V, V_o=0.9V$



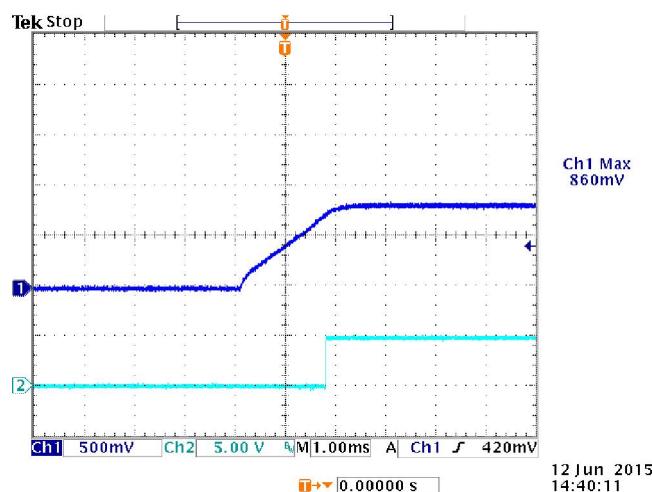
$V_{in}=12V, V_o=0.6V$

15. INPUT UNDER-VOLTAGE LOCKOUT



16. POWER GOOD

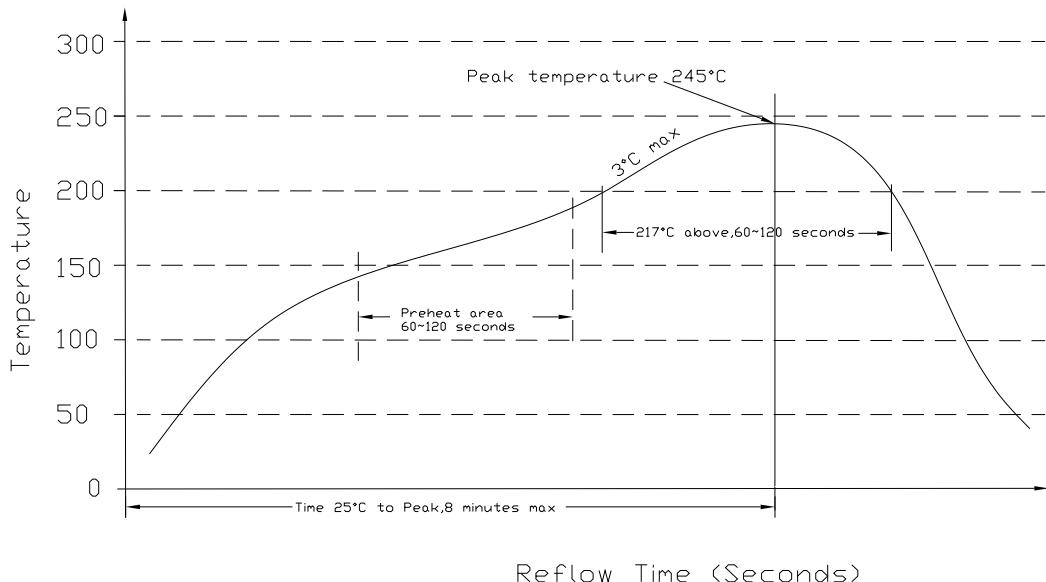
1. This module has a power good indicator output. Power good pin used positive logic and is open collector.
2. Maximum power good pin sinking current is 10mA.
3. The maximum voltage pulled up externally on Power Good pin should not exceed 5V.
4. When the output reaches 90% of the nominal set-point, the power good pin will be pulled high.



17. SOLDERING INFORMATION

The SRPE-50E1A0G modules are designed to be compatible with a Paste-In-Hole assembly process. The suggested Pb-free solder paste is Sn/Ag/Cu(SAC). The recommended reflow profile using Sn/Ag/Cu solder is shown in the following.

Recommended reflow peak temperature is 245 °C while the part can withstand peak temperature of 260 °C maximum for 10seconds. This profile should be used only as a guideline. Many other factors influence the success of SMT reflow soldering. Since your production environment may differ, please thoroughly review these guidelines with your process engineers.



18. MSL RATING

The SRPE-50E1A0G modules have a MSL rating of 3.

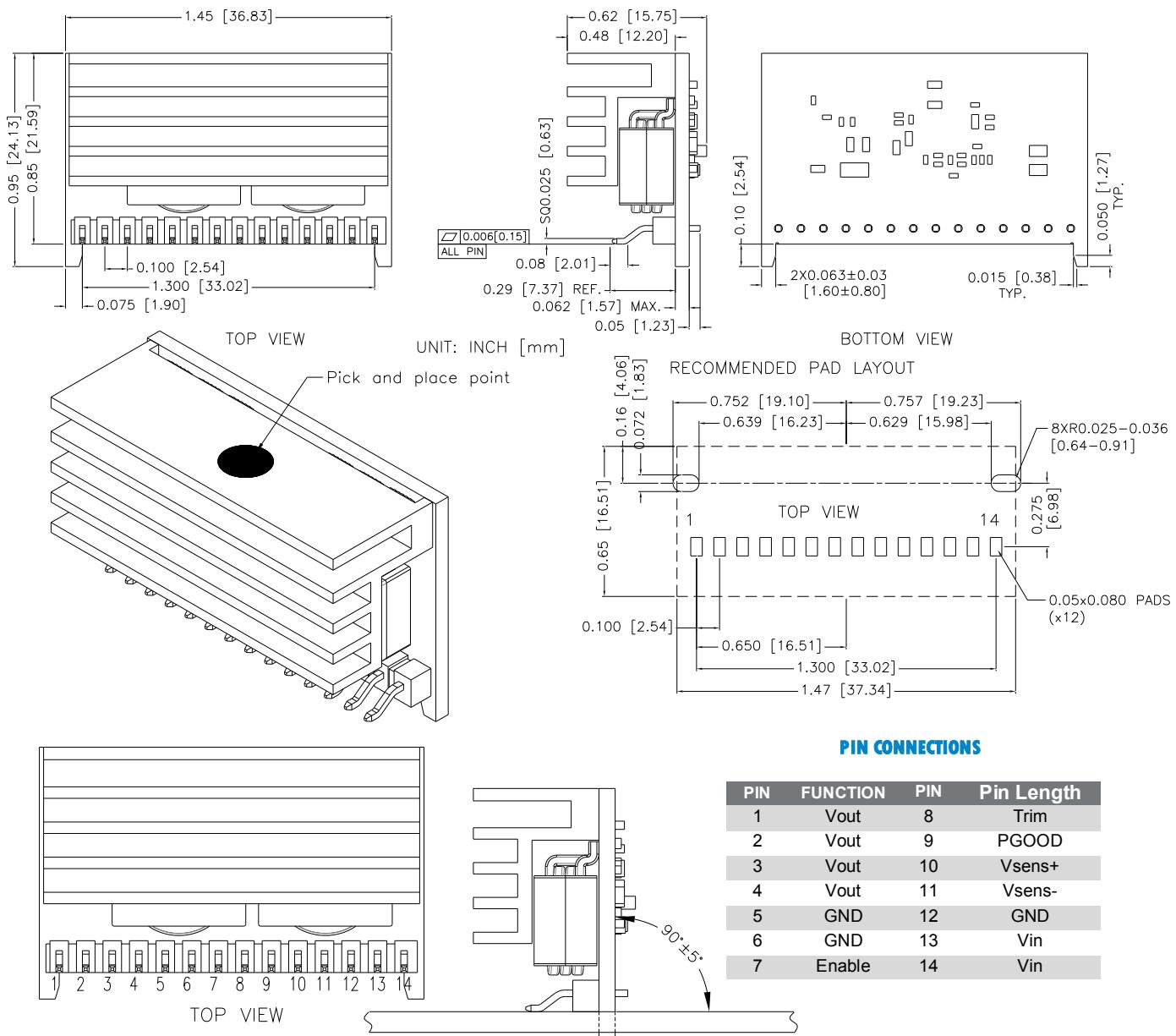
19. STORAGE AND HANDLING

The SRPE-50E1A0G modules are designed to be compatible with J-STD-033 Rev:A (Handling, Packing, Shipping and Use of Moisture /Reflow Sensitive surface Mount devices). Moisture barrier bags (MBB) with desiccant are applied. The recommended storage environment and handling procedure is detailed in J-STD-033.

20. PRE-BAKING

This component has been designed, handled, and packaged ready for pb-free reflow soldering. If the assembly shop follows J-STD-033 guidelines, no pre-bake of this component is required before being reflowed to a PCB. However, if the J-STD-033 guidelines are not followed by the assembler, Bel recommends that the modules should be pre-baked @ 120~125 °C for a minimum of 4 hours (preferably 24 hours) before reflow soldering.

21. MECHANICAL DIMENSIONS



NOTES:

All Pins: Material - Copper Alloy;
Finish – 3 micro inches minimum Gold over 50 micro inches minimum Nickel plate.

- 1) Undimensioned components are shown for visual reference only.
- 2) All dimensions in inches; Tolerances: $x.xx \pm 0.02$ in [0.51 mm]. $x.xxx \pm 0.010$ in [0.25 mm].

For more information on these products consult: tech.support@psbel.com

NUCLEAR AND MEDICAL APPLICATIONS - Products are not designed or intended for use as critical components in life support systems, equipment used in hazardous environments, or nuclear control systems.

TECHNICAL REVISIONS - The appearance of products, including safety agency certifications pictured on labels, may change depending on the date manufactured. Specifications are subject to change without notice.



Компания «ЭлектроПласт» предлагает заключение долгосрочных отношений при поставках импортных электронных компонентов на взаимовыгодных условиях!

Наши преимущества:

- Оперативные поставки широкого спектра электронных компонентов отечественного и импортного производства напрямую от производителей и с крупнейших мировых складов;
- Поставка более 17-ти миллионов наименований электронных компонентов;
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Техническая поддержка проекта, помошь в подборе аналогов, поставка прототипов;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- Лицензия ФСБ на осуществление работ с использованием сведений, составляющих государственную тайну;
- Поставка специализированных компонентов (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Aeroflex, Peregrine, Syfer, Eurofarad, Texas Instrument, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

Помимо этого, одним из направлений компании «ЭлектроПласт» является направление «Источники питания». Мы предлагаем Вам помошь Конструкторского отдела:

- Подбор оптимального решения, техническое обоснование при выборе компонента;
- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



Как с нами связаться

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